DECLARATION FOR PATENT APPLICATION

Attorney Docket: 25857
Page 1 of 2

As a below-named inventor(s), I/we hereby declare that:

My/Our residence(s), post office address(es) and citizenship(s) is/are as stated below next to my/our name(s).

I/We believe I/we am/are the original inventor, first and sole (if only one name is listed below) or the original, first and joint inventors (if plural names are listed below) of the subject matter which is claimed, and for which a patent is sought on the invention entitled:

FAN OUT TYPE WAFER LEVEL PACKAGE STRUCTURE AND METHOD OF THE SAME

		EAN	001	TIFE	MACEK	TEAFT	PACKAGE	SIKUCTURE	MND	WEIHOD	OF.	THE	SAME
the	specification	of	whic	h: (check	one)							

[X]	is attached hereto.	
[]	was filed on, as Serial No	_'
	and was amended on	(if applicable).

We hereby state that we have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

We acknowledge the duty to disclose information which is material to the patentability of this application as defined by $37\ \text{CFR}\ \S\ 1.56.$

We hereby claim foreign priority benefits under 35 U.S.C. § 119 of any foreign application(s) for patent or inventor's certificate listed below, and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Applications:

		Prior	ity Claimed
(Application No.)	(Country)	(Day/Month/Year Filed)	[] [] Yes No
(Application No.)	(Country)	/ / (Day/Month/Year Filed)	[] [] Yes No
(Application No.)	(Country)	(Day/Month/Year Filed)	[] [] Yes No

We hereby appoint Gary M. Nath, Reg. No. 26,965; Harold L. Novick, Reg. No. 26,011; Todd L. Juneau, Reg. No. 40,669; Lee C. Heiman, Reg. No. 41,827; Jerald L. Meyer, Reg. No. 41,194; Joshua B. Goldberg, Reg. No. 44,126; Marvin C. Berkowitz, Reg. No. 47,421; Sheldon M. McGee, Reg. No. 50,454; Tanya E. Harkins, Reg. No. 52,993; Robert C. Ryan, Reg. 29,343; and Derek Richmond, Reg. No. 45,771; as my attorneys to prosecute this application and transact all business in the U.S. Patent and Trademark Office connected therewith.

Direct Telephone Calls to:

Gary M. Nath (202) 775-8383 Send Correspondence to:
NATH & ASSOCIATES PLLC
Sixth Floor
1030 15th Street, N.W.
Washington, D.C. 20005 U.S.A.

We hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by 35 U.S.C. § 112, first paragraph, I/we acknowledge the duty to disclose material information as defined in 37 CFR § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(U.S.	Application	Serial	No.)	(U.S.	Filing	Date)	(Statuspatented,	pending,	abandoned)
(U.S.	Application	Serial	No.)	(U.S.	Filing	Date)	(Statuspatented,	pending,	abandoned)

DECLARATION FOR PATENT APPLICATION

Post Office Address: Same as Residence

Attorney Docket: 25857

Page 2 of 2

I/We hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional application(s) listed below:

(Application Number(s)	Filing Date
statements made on information and belief are are made with the knowledge that willful fals	made herein of my own knowledge are true and that all be believed to be true; and further that these statements e statements and the like so made are punishable by fine 001 and that such willful false statements may jeopardize issued thereon.
Full name of sole or first inventor:Wen-	-Kun_YANG
Inventor's Signature	Date
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Country of Citizenship: R.O.C.	
Post Office Address: Same as Resi	dence
Full name of second inventor: Wen-Pin YAN Inventor's Signature	
Residence: <u>No. 112, Julian St., Hsinchu, Ta</u>	niwan 300, R. O. C.
Country of Citizenship: R. O. C.	
Post Office Address: Same as Resi	dence
Full name of third inventor: Shih-Li CHEN	3
Inventor's Signature	Date
Residence: 7F., No. 22, Sanchong Rd., Jhudo	ong Township, Hsinchu County, Taiwan 310, R. O. C.
Country of Citizenship: R. O. C.	